



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6020A uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =60V,I_D =20A
 R_{DS(ON)} <25mΩ @ V_{GS}=10V
 R_{DS(ON)} <31mΩ @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!

(3) S Schematic diagram

(2) D

(1) GO



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6020A	NCE6020A	TO-220-3L	-	-	-

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	60	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	20	A	
Drain Current-Continuous(Tc=100 ℃)	I _D (100℃)	14	А	
Pulsed Drain Current	Ідм	60	А	
Maximum Power Dissipation	PD	45	W	
Derating factor		0.3	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	72	mJ	
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C	



Pb Free Product



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	Rejc	3.3	°C/W
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Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	·						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)	·		•				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.6	2.5	V	
Drain-Source On-State Resistance		V _{GS} =10V, I _D =20A	-	21	25	mΩ	
	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A		25.5	31		
Forward Transconductance	g fs	V _{DS} =5V,I _D =5A	11	-	-	S	
Dynamic Characteristics (Note4)		·					
Input Capacitance	Clss		-	973.2	-	PF	
Output Capacitance	Coss	V _{DS} =30V,V _{GS} =0V, F=1.0MHz	-	61.2	-	PF	
Reverse Transfer Capacitance	Crss		-	58.8	-	PF	
Switching Characteristics (Note 4)	·						
Turn-on Delay Time	t _{d(on)}		-	5	-	nS	
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =6.7Ω	-	2.6	-	nS	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =3Ω	-	16.1	-	nS	
Turn-Off Fall Time	t _f		-	2.3	-	nS	
Total Gate Charge	Qg		-	25		nC	
Gate-Source Charge	Q _{gs}	$V_{DS}=30V, I_{D}=4.5A,$	-	4.5		nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6.5		nC	
Drain-Source Diode Characteristics	·						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V	
Diode Forward Current (Note 2)	Is		-	-	20	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =20A	-	29	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	49	-	nC	
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD					

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^\circ\mathrm{C}$,VDD=30V,VG=10V,L=0.5mH,Rg=25 Ω

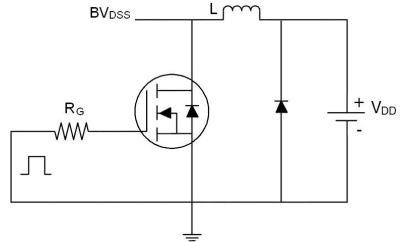


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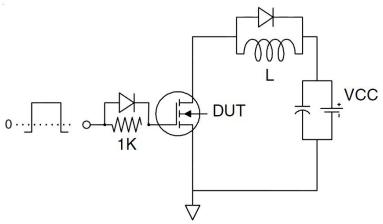




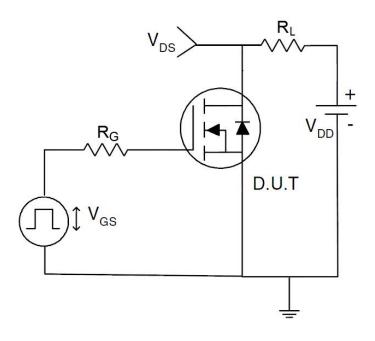
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



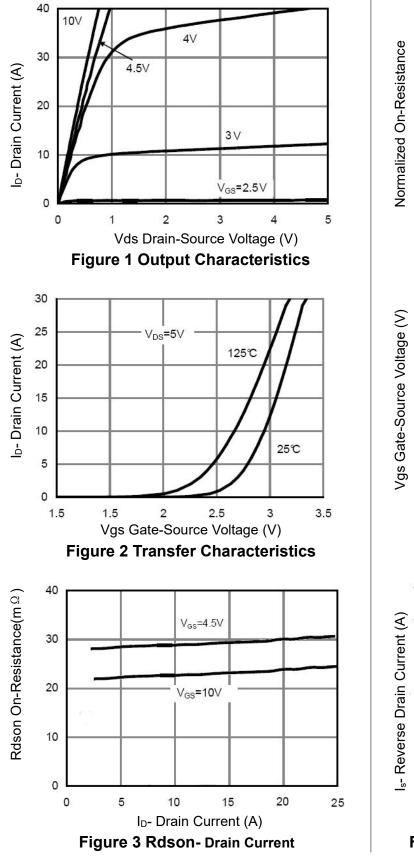
3) Switch Time Test Circuit

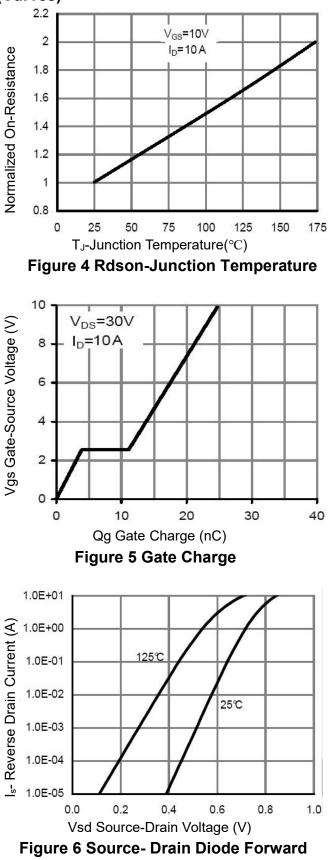










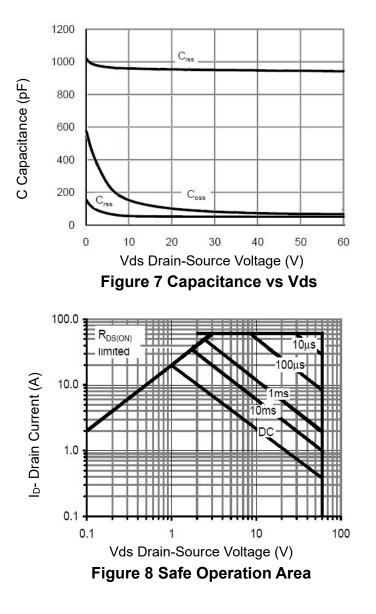




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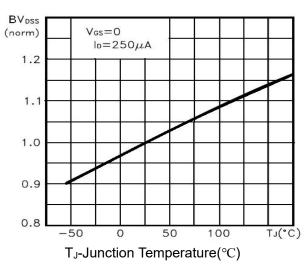


Figure 9 BV_{DSS} vs Junction Temperature

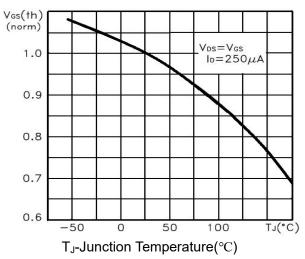
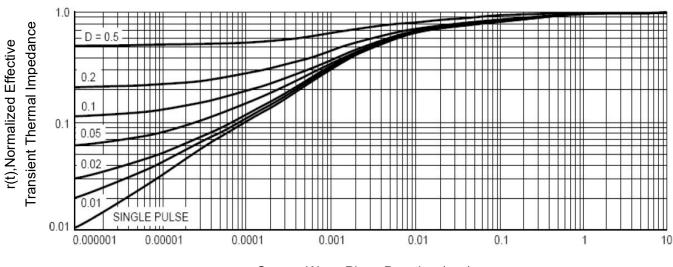


Figure 10 V_{GS(th)} vs Junction Temperature



Square Wave Pluse Duration (sec)
Figure 11 Normalized Maximum Transient Thermal Impedance

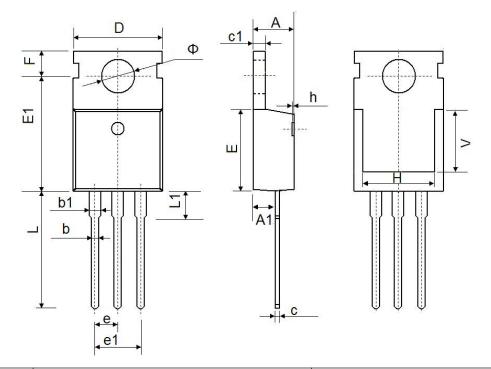


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TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540) TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Φ	3.400	3.800	0.134	0.150	





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